

30V N-Channel Enhancement-Mode Mosfet

30V N 沟道增强型 MOS 管

VDS = 30V

RDS(ON), Vgs@10.0V, Ids@8.0A = 14.0mΩ

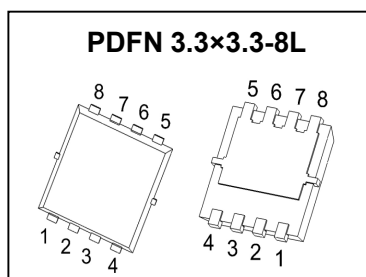
RDS(ON), Vgs@4.5V, Ids@6.0A = 21.0mΩ

Features 特性

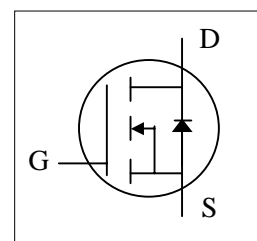
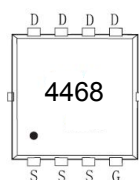
Advanced trench process technology 高级的加工技术

High Density Cell Design For Ultra Low On-Resistance 极低的导通电阻高密度的单元设计

High Power and Current handling capability 大功率高电流



Marking



Maximum Ratings and Thermal Characteristics (TA = 25 °C unless otherwise noted) 25 °C 极限参数和热特性

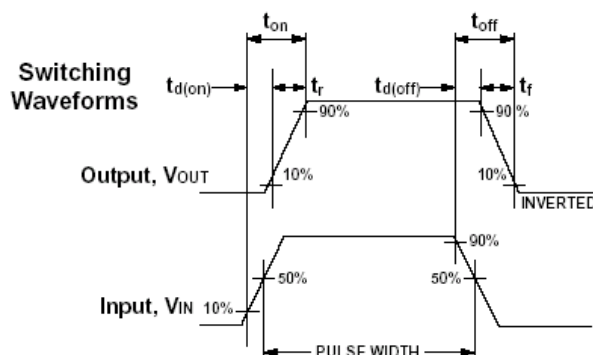
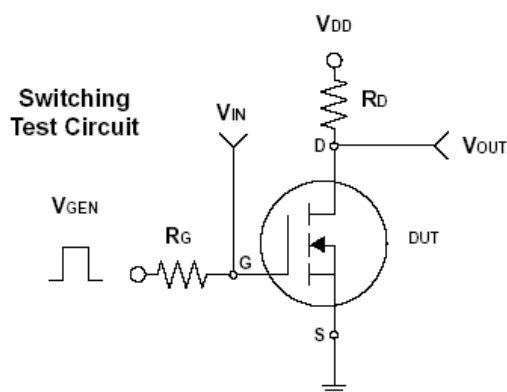
Parameter 极限参数	Symbol 符号	Limit 范围	Unit 单位
Drain-Source Voltage 漏源电压	V _{DS}	30	V
Gate-Source Voltage 栅源电压	V _{GS}	± 20	
Continuous Drain Current 连续漏极电流	I _D	25	A
Pulsed Drain Current 脉冲漏极电流	I _{DM}	80	
Maximum Power Dissipation 最大耗散功率	P _D	1.5	W
		1.2	
Operating Junction and Storage Temperature Range 使用及储存温度	T _J , T _{stg}	-55 to 150	°C
Junction-to-Ambient Thermal Resistance (PCB mounted) 结环热阻	R _{θJA}	83.5	°C/W

Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm², t ≤ 5 s.

ELECTRICAL CHARACTERISTICS 一般电气特性

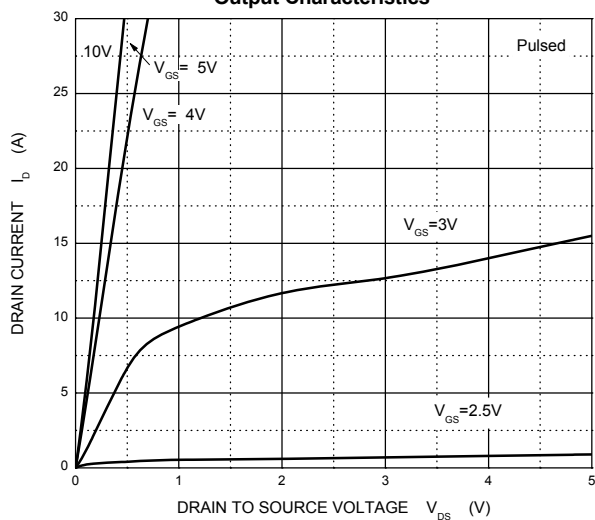
Parameter 参数	符号	Test Condition 测试条件	最小值	典型值	最大值	单位
Static 静态参数						
Drain-Source Breakdown Voltage 漏源击穿电压	BV _{DSS}	V _{GS} = 0V, I _D = 250uA	30			V
Drain-Source On-State Resistance 漏源导通电阻	R _{DS(on)}	V _{GS} = 10.0 V, I _D = 8.0 A		10.0	14.0	mΩ
Drain-Source On-State Resistance 漏源导通电阻	R _{DS(on)}	V _{GS} = 4.5V, I _D = 6.0 A		15.0	21.0	
Gate Threshold Voltage 开启电压	V _{GS(th)}	V _{DS} =V _{GS} , I _D = 250uA	1.0	1.8	3.0	V
Zero Gate Voltage Drain Current 零栅压漏极电流	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V			1	uA
Gate Body Leakage 漏极短路时截止栅电流	I _{GSS}	V _{GS} = ± 20V, V _{DS} = 0V			±100	nA
Forward Transconductance 正向跨导	g _{fs}	V _{DS} =5.0 V, I _D = 8.0A		10		S
Dynamic 动态参数						
Total Gate Charge 栅极总电荷	Q _g	V _{DS} = 15V, I _D = 8.0A V _{GS} = 4.5V		8.2		nC
Gate-Source Charge 栅-源极电荷	Q _{gs}			2.0		
Gate-Drain Charge 栅-漏极电荷	Q _{gd}			3.2		
Turn-On Delay Time 导通延迟时间	t _{d(on)}	V _{DD} = 15V, R _G = 6Ω I _D = 8.0A , V _{GS} = 4.5V		12.7		ns
Turn-On Rise Time 导通上升时间	t _r			11.6		
Turn-Off Delay Time 关断延迟时间	t _{d(off)}			41.4		
Turn-Off Fall Time 关断下降时间	t _f			10.3		
Input Capacitance 输入电容	C _{iss}	V _{DS} = 15 V, V _{GS} = 0V f = 1.0 MHz		900		pF
Output Capacitance 输出电容	C _{oss}			128		
Reverse Transfer Capacitance 反向传输电容	C _{rss}			75		
Source-Drain Diode 源漏二极管参数						
Max. Diode Forward Current 最大正向电流	I _S				10	A
Diode Forward Voltage 正向电压	V _{SD}	I _S =8.0 A, V _{GS} = 0V			1.2	V

Note: Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$ 注意: 脉冲测试: 脉冲宽度 $\leq 300\mu s$ 死区 $\leq 2\%$

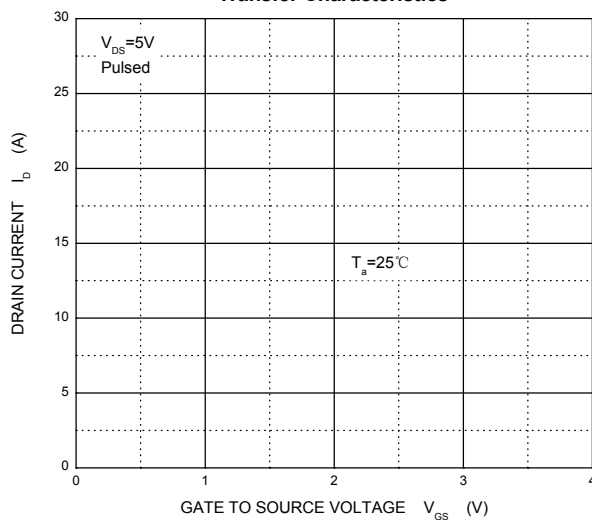


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

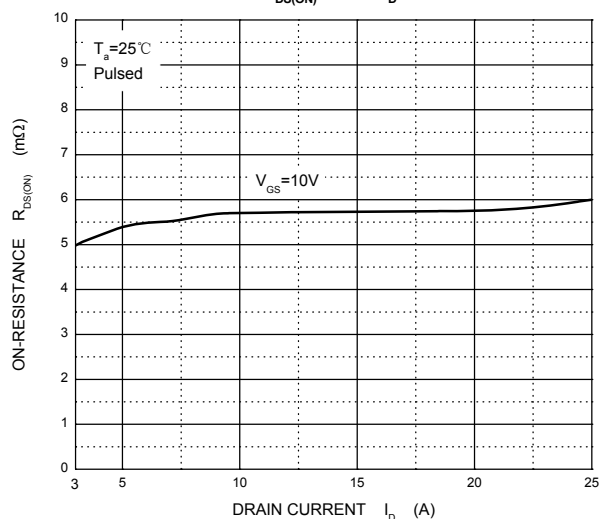
Output Characteristics



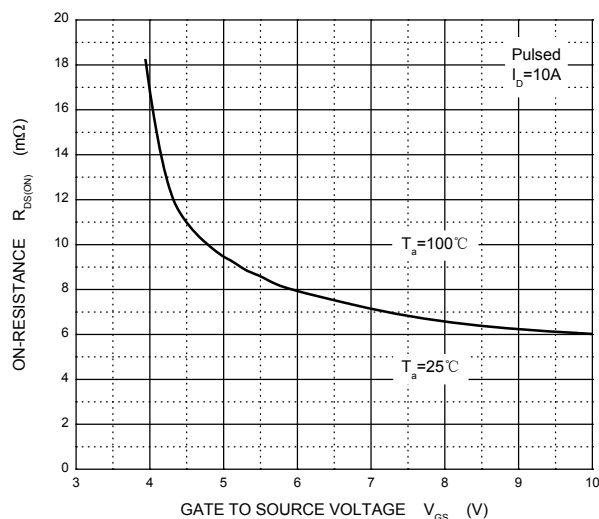
Transfer Characteristics



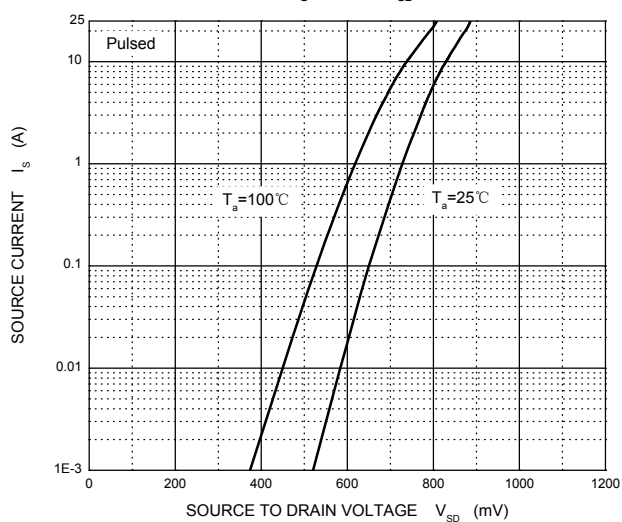
$R_{DS(ON)}$ — I_D



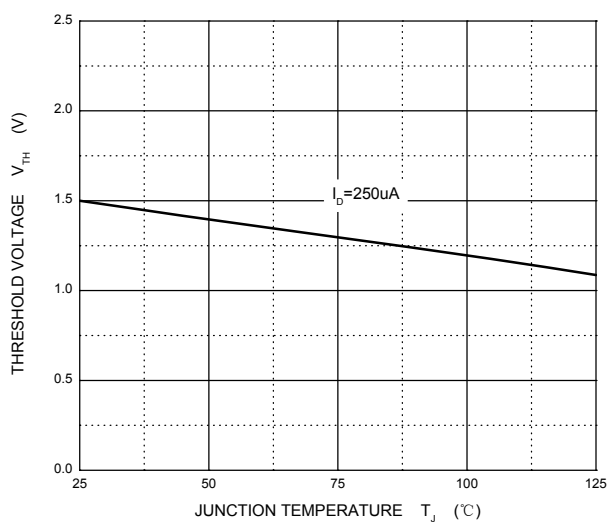
$R_{DS(ON)}$ — V_{GS}



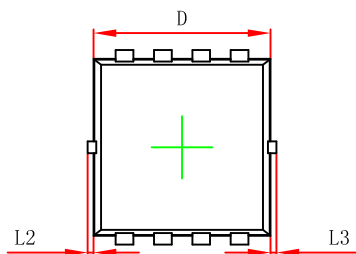
I_S — V_{SD}



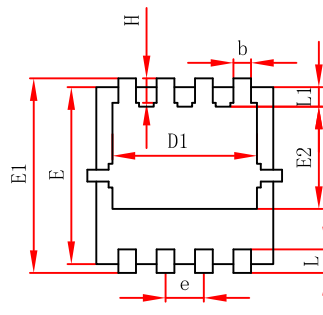
Threshold Voltage



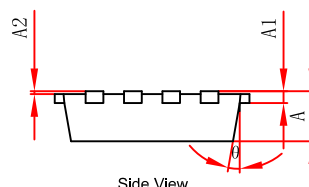
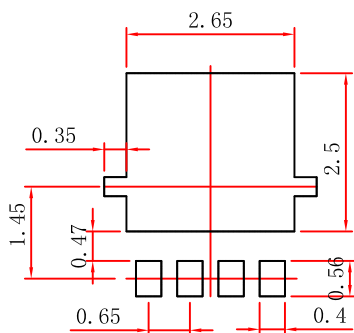
PDFN 3.3*3.3-8L Package Outline Dimensions



Top View
 [顶视图]



Bottom View
 [背视图]



Side View
 [侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°